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**Vishay Semiconductors** 



### Phase Control Thyristors (Hockey PUK Version), 350 A



TO-200AB (A-PUK)

PRODUCT SUMMARY					
Package	TO-200AB (A-PUK)				
Diode variation	Single SCR				
I <sub>T(AV)</sub>	350 A				
V <sub>DRM</sub> /V <sub>RRM</sub>	400 V to 2000 V				
V <sub>TM</sub>	1.96 V				
I <sub>GT</sub>	150 mA				
TJ	-40 °C to 125 °C				

#### FEATURES

- Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AB (A-PUK)
- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **TYPICAL APPLICATIONS**

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS					
PARAMETER	TEST CONDITIONS	VALUES	UNITS		
		350	A		
I <sub>T(AV)</sub>	T <sub>hs</sub>	55	°C		
I <sub>T(RMS)</sub>		660	A		
	T <sub>hs</sub>	25	°C		
	50 Hz	5000	٨		
I <sub>TSM</sub>	60 Hz	5230	- A		
12+	50 Hz	125	kA <sup>2</sup> s		
l <sup>2</sup> t	60 Hz	114	KA-S		
V <sub>DRM</sub> /V <sub>RRM</sub>		400 to 2000	V		
tq	Typical	100	μs		
TJ		-40 to 125	°C		

#### **ELECTRICAL SPECIFICATIONS**

VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE	V <sub>DRM</sub> /V <sub>RRM</sub> , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V <sub>RSM</sub> , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	$I_{DRM}/I_{RRM}$ MAXIMUM AT T <sub>J</sub> = T <sub>J</sub> MAXIMUM mA				
	04	400	500					
	08	800	900					
VS-ST180CC	12	1200	1300	30				
V3-31100CC	16	1600	1700	30				
	18	1800	1900					
	20	2000	2100					

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COMPLIANT



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ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS
Maximum average on-state current	L	180° condu	ction, half sine	wave	350 (140)	А
at heatsink temperature	I <sub>T(AV)</sub>	double side	(single side) co	oled	55 (85)	°C
Maximum RMS on-state current	I <sub>T(RMS)</sub>	DC at 25 °C	heatsink temp	erature double side cooled	660	
		t = 10 ms	No voltage		5000	
Maximum peak, one-cycle	l	t = 8.3 ms	reapplied		5230	A kA <sup>2</sup> s
non-repetitive surge current	I <sub>TSM</sub>	t = 10 ms	100 % V <sub>RRM</sub>		4200	
		t = 8.3 ms	reapplied	Sinusoidal half wave.	4400	
Maria 20 factoria		t = 10 ms	No voltage reapplied	initial $T_J = T_J$ maximum	125	
	l <sup>2</sup> t	t = 8.3 ms			114	
Maximum I <sup>2</sup> t for fusing		t = 10 ms	100 % V <sub>RRM</sub>		88	
		t = 8.3 ms	reapplied		81	
Maximum I <sup>2</sup> $\sqrt{t}$ for fusing	l²√t	t = 0.1 to 10	) ms, no voltage	reapplied	1250	kA²√s
Low level value of threshold voltage	V <sub>T(TO)1</sub>	(16.7 % x π	$x  _{T(AV)} < l < \pi x$	$I_{T(AV)}$ ), $T_J = T_J$ maximum	1.08	v
High level value of threshold voltage	V <sub>T(TO)2</sub>	$(I > \pi \times I_{T(AV)})$	$(I > \pi x I_{T(AV)}), T_J = T_J maximum$			v
Low level value of on-state slope resistance	r <sub>t1</sub>	(16.7 % x $\pi$ x $I_{T(AV)} < I < \pi$ x $I_{T(AV)}$ ), $T_J = T_J$ maximum		1.18	mΩ	
High level value of on-state slope resistance	r <sub>t2</sub>	$(I > \pi x I_{T(AV)}), T_J = T_J maximum$		1.14	1115.2	
Maximum on-state voltage	$V_{TM}$	$I_{pk} = 750 \text{ A}, T_J = T_J \text{ maximum, } t_p = 10 \text{ ms sine pulse}$			1.96	V
Maximum holding current	Ι <sub>Η</sub>			600	mA	
Maximum (typical) latching current	١L	T <sub>J</sub> = 25 °C, anode supply 12 V resistive load 100		1000 (300)		

SWITCHING							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Maximum non-repetitive rate of rise of turned-on current	dl/dt	Gate drive 20 V, 20 $\Omega,t_r \leq 1~\mu s$ $T_J$ = $T_J$ maximum, anode voltage $\leq 80~\%~V_{DRM}$	1000	A/µs			
Typical delay time	t <sub>d</sub>	Gate current 1 A, dl <sub>g</sub> /dt = 1 A/ $\mu$ s V <sub>d</sub> = 0.67 % V <sub>DRM</sub> , T <sub>J</sub> = 25 °C	1.0				
Typical turn-off time	tq	$I_{TM}$ = 300 A, $T_J$ = $T_J$ maximum, dl/dt = 20 A/µs, $V_R$ = 50 V, dV/dt = 20 V/µs, gate 0 V 100 $\Omega,$ $t_p$ = 500 µs	100	μs			

BLOCKING							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNIT S			
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J maximum linear to 80 \% rated V_{DRM}$	500	V/µs			
Maximum peak reverse and off-state leakage current	I <sub>RRM</sub> , I <sub>DRM</sub>	$T_J = T_J$ maximum, rated $V_{DRM}/V_{RRM}$ applied	30	mA			

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TRIGGERING						
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES		UNIT
FARAMETER	STMDOL		EST CONDITIONS	typ.	max.	S
Maximum peak gate power	P <sub>GM</sub>	$T_J = T_J$ maximum,	$t_p \le 5 \text{ ms}$	10		w
Maximum average gate power	P <sub>G(AV)</sub>	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	vv
Maximum peak positive gate current	I <sub>GM</sub>			3	.0	А
Maximum peak positive gate voltage	+ V <sub>GM</sub>	$T_J = T_J$ maximum, $t_p \le 5$ ms 20		20	v	
Maximum peak negative gate voltage	- V <sub>GM</sub>				.0	
	I <sub>GT</sub>	T <sub>J</sub> = - 40 °C		180	-	
DC gate current required to trigger		T <sub>J</sub> = 25 °C		90	150	mA
		T <sub>J</sub> = 125 °C	Maximum required gate trigger/ current/voltage are the lowest value	40	-	
		$T_J = -40 \degree C$ which will trigger all units 12 V	2.9	-		
DC gate voltage required to trigger	V <sub>GT</sub>	T <sub>J</sub> = 25 °C	anode to cathode applied	1.8	3.0	V
		T <sub>J</sub> = 125 °C		1.2	-	
DC gate current not to trigger	I <sub>GD</sub>	• TJ = TJ maximum	Maximum gate current/voltage not to trigger is the maximum value which will not trigger any unit with	10		mA
DC gate voltage not to trigger	V <sub>GD</sub>	ij – ijilaxillulli	rated V <sub>DRM</sub> anode to cathode applied	0.25		v

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER SYMBOL		TEST CONDITIONS	VALUES	UNIT S		
Maximum operating junction temperature range	TJ		-40 to 125	°C		
Maximum storage temperature range	T <sub>Stg</sub>		-40 to 150			
Maximum thermal resistance, junction to heatsink	R <sub>thJ-hs</sub>	DC operation single side cooled	0.17			
		DC operation double side cooled	0.08	к/w		
Maximum thermal resistance,		DC operation single side cooled	0.033	r./ w		
case to heatsink	R <sub>thC-hs</sub>	DC operation double side cooled	0.017	1		
Mounting force, ± 10 %			4900 (500)	N (kg)		
Approximate weight			50	g		
Case style		See dimensions - link at the end of datasheet	TO-200AB (A	A-PUK)		



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#### **Vishay Semiconductors**

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Conduction angle

20

90

180°

$\Delta \mathbf{R}_{thJC}$	CONDUCTION	ł

CONDUCTION ANGLE		OIDAL JCTION	RECTANGULAR CONDUCTION		TEST CONDITIONS	UNITS	
	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE			
180°	0.015	0.015	0.011	0.011			
120°	0.018	0.019	0.019	0.019			
90°	0.024	0.024	0.026	0.026	$T_J = T_J$ maximum	K/W	
60°	0.035	0.035	0.036	0.037			
30°	0.060	0.060	0.060	0.061			

#### Note

80

70

60

50

40

30

20

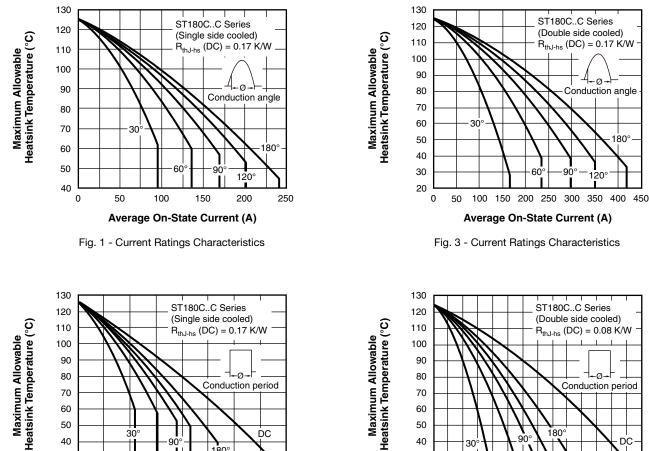
0

30

100

Γ

The table above shows the increment of thermal resistance R<sub>thJC</sub> when devices operate at different conduction angles than DC



Conduction period

180

300

120

200

Average On-State Current (A)

Fig. 2 - Current Ratings Characteristics

ĎС

400

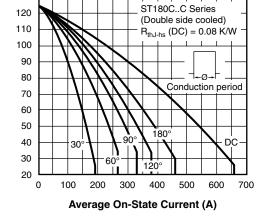
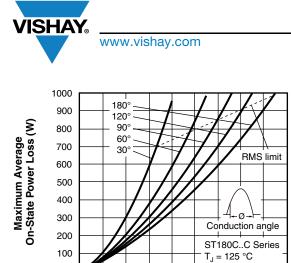


Fig. 4 - Current Ratings Characteristics

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0 50 100 150

Average On-State Current (A)

200 250 300 350 400 450

Fig. 5 - On-State Power Loss Characteristics

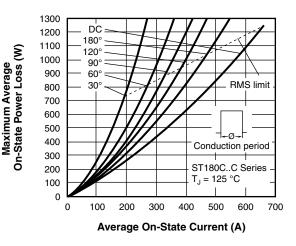
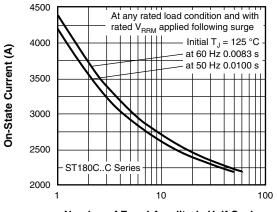


Fig. 6 - On-State Power Loss Characteristics



Peak Half Sine Wave

Number of Equal Amplitude Half Cycle Current Pulses (N)

Fig. 7 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

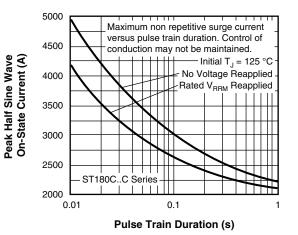
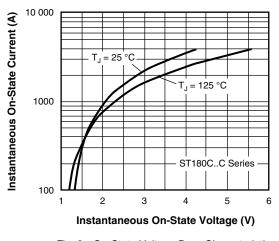
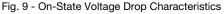
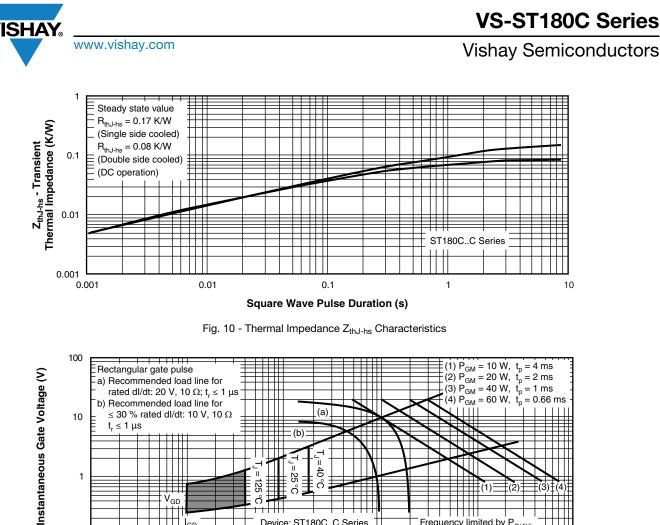


Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled







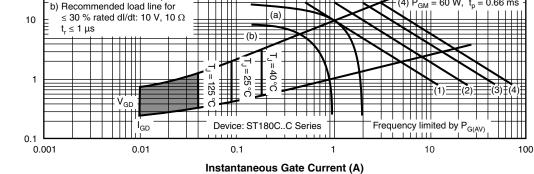
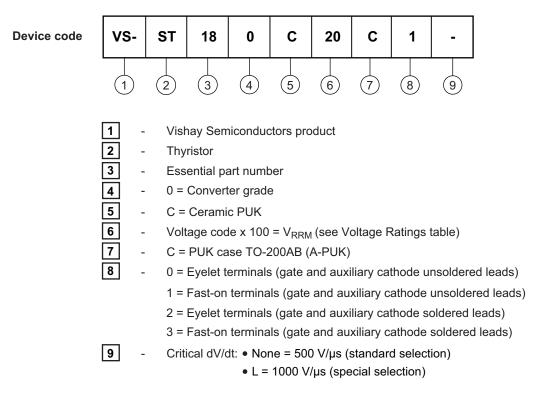


Fig. 11 - Gate Characteristics

#### **Vishay Semiconductors**



#### **ORDERING INFORMATION TABLE**



LINKS TO RELATED DOCUMENTS					
Dimensions www.vishay.com/doc?95074					

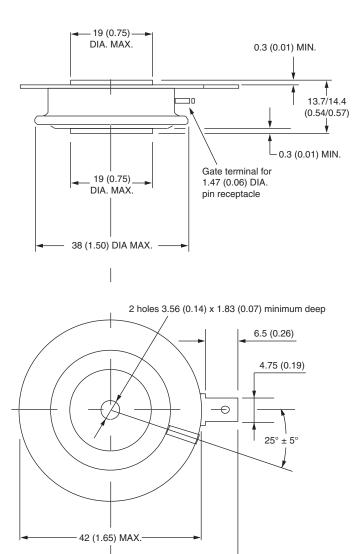


**Vishay Semiconductors** 

## TO-200AB (A-PUK)

#### **DIMENSIONS** in millimeters (inches)

Anode to gate Creepage distance: 7.62 (0.30) minimum Strike distance: 7.12 (0.28) minimum



Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)

28 (1.10)



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